

PCA9548A

8-channel I²C-bus switch with reset

Rev. 5.1 — 1 October 2015

Product data sheet

1. General description

The PCA9548A is an octal bidirectional translating switch controlled via the I²C-bus. The SCL/SDA upstream pair fans out to eight downstream pairs, or channels. Any individual SCx/SDx channel or combination of channels can be selected, determined by the contents of the programmable control register.

An active LOW reset input allows the PCA9548A to recover from a situation where one of the downstream I²C-buses is stuck in a LOW state. Pulling the RESET pin LOW resets the I²C-bus state machine and causes all the channels to be deselected as does the internal Power-on reset function.

The pass gates of the switches are constructed such that the V_{DD} pin can be used to limit the maximum high voltage which will be passed by the PCA9548A. This allows the use of different bus voltages on each pair, so that 1.8 V or 2.5 V or 3.3 V parts can communicate with 5 V parts without any additional protection. External pull-up resistors pull the bus up to the desired voltage level for each channel. All I/O pins are 6 V tolerant.

2. Features and benefits

- 1-of-8 bidirectional translating switches
- I²C-bus interface logic; compatible with SMBus standards
- Active LOW reset input
- Three address pins allowing up to eight devices on the I²C-bus
- Channel selection via I²C-bus, in any combination
- Power-up with all switch channels deselected
- Low R_{on} switches
- Allows voltage level translation between 1.8 V, 2.5 V, 3.3 V and 5 V buses
- No glitch on power-up
- Supports hot insertion
- Low standby current
- Operating power supply voltage range of 2.3 V to 5.5 V
- 6 V tolerant inputs
- 0 Hz to 400 kHz clock frequency
- ESD protection exceeds 2000 V HBM per JESD22-A114 and 1000 V CDM per JESD22-C101
- Latch-up testing is done to JEDEC Standard JESD78 which exceeds 100 mA
- Three packages offered: SO24, TSSOP24, and HVQFN24



8-channel I²C-bus switch with reset

3. Ordering information

Table 1. Ordering information

Type number	Topside	Package	Package								
	marking	Name	Description	Version							
PCA9548ABS	548A	HVQFN24	plastic thermal enhanced very thin quad flat package; no leads; 24 terminals; body $4\times4\times0.85$ mm	SOT616-1							
PCA9548AD	PCA9548AD	SO24	plastic small outline package; 24 leads; body width 7.5 mm	SOT137-1							
PCA9548APW	PCA9548A	TSSOP24	plastic thin shrink small outline package; 24 leads; body width 4.4 mm	SOT355-1							

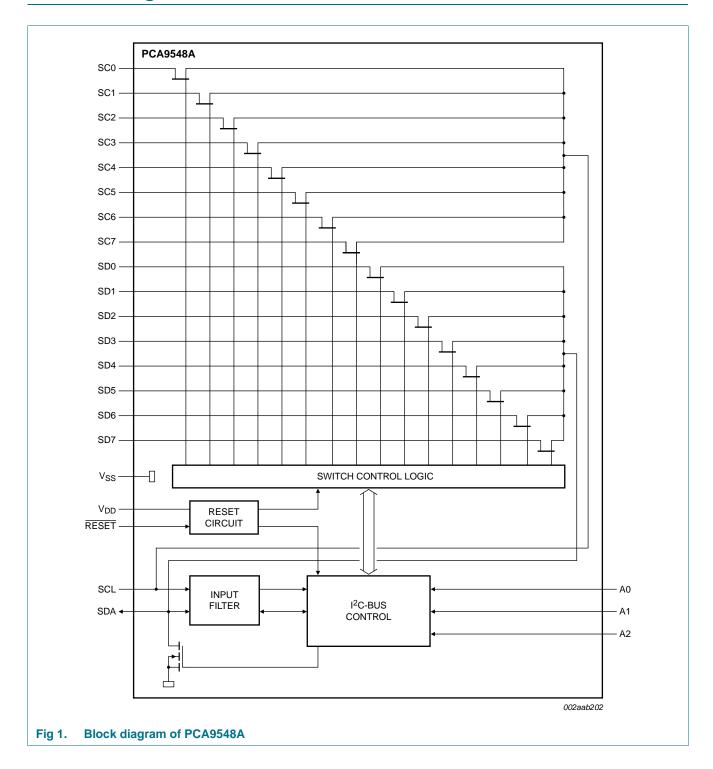
3.1 Ordering options

Table 2. Ordering options

Type number	Orderable part number	Package	Packing method	Minimum order quantity	Temperature
PCA9548ABS	PCA9548ABS,118	HVQFN24	Reel 13" Q1/T1 *Standard mark SMD	6000	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$
	PCA9548ABSHP	HVQFN24	Reel 13" Q2/T3 *Standard mark SMD	6000	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$
PCA9548AD	PCA9548AD,112	SO24	Standard marking IC's tube - DSC bulk pack	1200	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$
	PCA9548AD,118	SO24	Reel 13" Q1/T1 *Standard mark SMD	1000	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$
PCA9548APW	PCA9548APW,112	TSSOP24	Standard marking IC's tube - DSC bulk pack	1575	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$
	PCA9548APW,118	TSSOP24	Reel 13" Q1/T1 *Standard mark SMD	2500	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$

8-channel I²C-bus switch with reset

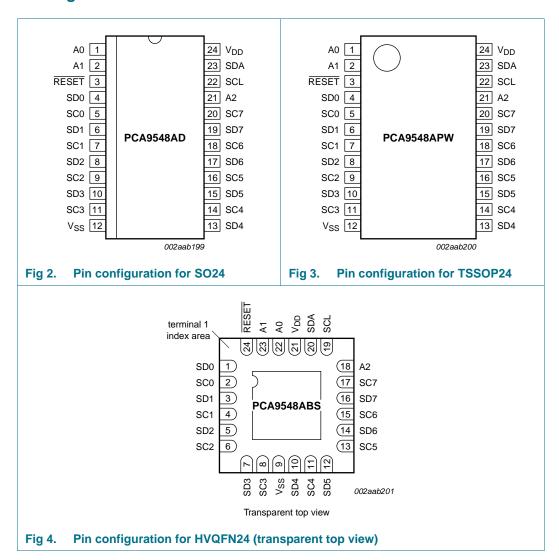
4. Block diagram



8-channel I²C-bus switch with reset

5. Pinning information

5.1 Pinning



8-channel I²C-bus switch with reset

5.2 Pin description

Table 3. Pin description

Symbol	Pin		Description				
	SO24, TSSOP24	HVQFN24					
A0	1	22	address input 0				
A1	2	23	address input 1				
RESET	3	24	active LOW reset input				
SD0	4	1	serial data 0				
SC0	5	2	serial clock 0				
SD1	6	3	serial data 1				
SC1	7	4	serial clock 1				
SD2	8	5	serial data 2				
SC2	9	6	serial clock 2				
SD3	10	7	serial data 3				
SC3	11	8	serial clock 3				
V_{SS}	12	9 <u>[1]</u>	supply ground				
SD4	13	10	serial data 4				
SC4	14	11	serial clock 4				
SD5	15	12	serial data 5				
SC5	16	13	serial clock 5				
SD6	17	14	serial data 6				
SC6	18	15	serial clock 6				
SD7	19	16	serial data 7				
SC7	20	17	serial clock 7				
A2	21	18	address input 2				
SCL	22	19	serial clock line				
SDA	23	20	serial data line				
V_{DD}	24	21	supply voltage				

^[1] HVQFN24 package die supply ground is connected to both the V_{SS} pin and the exposed center pad. The V_{SS} pin must be connected to supply ground for proper device operation. For enhanced thermal, electrical, and board-level performance, the exposed pad needs to be soldered to the board using a corresponding thermal pad on the board, and for proper heat conduction through the board thermal vias need to be incorporated in the PCB in the thermal pad region.

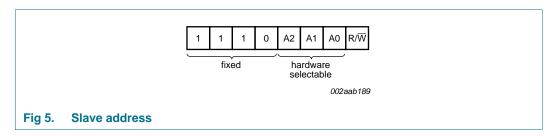
8-channel I²C-bus switch with reset

6. Functional description

Refer to Figure 1 "Block diagram of PCA9548A".

6.1 Device address

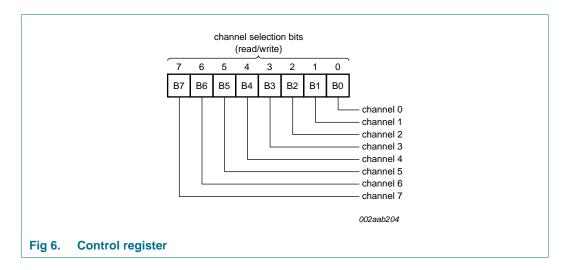
Following a START condition, the bus master must output the address of the slave it is accessing. The address of the PCA9548A is shown in Figure 5. To conserve power, no internal pull-up resistors are incorporated on the hardware selectable address pins and they must be pulled HIGH or LOW.



The last bit of the slave address defines the operation to be performed. When set to logic 1 a read is selected, while a logic 0 selects a write operation.

6.2 Control register

Following the successful acknowledgement of the slave address, the bus master will send a byte to the PCA9548A, which will be stored in the control register. If multiple bytes are received by the PCA9548A, it will save the last byte received. This register can be written and read via the I^2C -bus.



8-channel I²C-bus switch with reset

6.2.1 Control register definition

One or several SCx/SDx downstream pair, or channel, is selected by the contents of the control register. This register is written after the PCA9548A has been addressed. The contents of the control byte are used to determine which channel is to be selected. When a channel is selected, the channel will become active after a STOP condition has been placed on the I²C-bus. This ensures that all SCx/SDx lines will be in a HIGH state when the channel is made active, so that no false conditions are generated at the time of connection.

rable 4. Control register, write—channel selection, Read—channel sta	Table 4.	Control register: Write—channel selection; Read—cha	nnel statu
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B7	В6	B5	B4	В3	B2	B1	В0	Command
X	X	X	X	Х	X	Х	0	channel 0 disabled
^	^	^	^	^	^	^	1	channel 0 enabled
X	Χ	Χ	Χ	Х	X	0	X	channel 1 disabled
^	^	٨	^	^	^	1		channel 1 enabled
X	Χ	Χ	Χ	Х	0	X	Χ	channel 2 disabled
^	^	٨	^	^	1			channel 2 enabled
X	Χ	Χ	Х	0	_ X	Х	Y	channel 3 disabled
^	^	٨	^	1		٨	Χ	channel 3 enabled
X	Х	Χ	0	_ X	X	Х	Χ	channel 4 disabled
^	^	^	1		^	^	^	channel 4 enabled
X	Х	0	X	Х	X	Х	X	channel 5 disabled
^	^	1	_ ^	^	^	^	^	channel 5 enabled
X	0	_ X	X	Х	X	Х	Х	channel 6 disabled
^	1		^	^	^	^	^	channel 6 enabled
0	_ X	X	X	Х	X	Х	X	channel 7 disabled
1		^	Λ	^	Λ	^	٨	channel 7 enabled

Remark: Multiple channels can be enabled at the same time. Example: B7 = 0, B6 = 1, B5 = 0, B4 = 0, B3 = 1, B2 = 1, B1 = 0, B0 = 0, means that channels 7, 5, 4, 1 and 0 are disabled and channels 6, 3, and 2 are enabled. Care should be taken not to exceed the maximum bus capacitance. Default condition is all zeroes.

6.3 RESET input

The $\overline{\text{RESET}}$ input is an active LOW signal which may be used to recover from a bus fault condition. By asserting this signal LOW for a minimum of $t_{\text{W(rst)L}}$, the PCA9548A will reset its register and I²C-bus state machine and will deselect all channels. The $\overline{\text{RESET}}$ input must be connected to V_{DD} through a pull-up resistor.

6.4 Power-on reset

When power is applied to V_{DD} , an internal Power-On Reset (POR) holds the PCA9548A in a reset condition until V_{DD} has reached V_{POR} . At this point, the reset condition is released and the PCA9548A register and I²C-bus state machine are initialized to their default states (all zeroes) causing all the channels to be deselected. Thereafter, V_{DD} must be lowered below 0.2 V for at least 5 μ s in order to reset the device.

8-channel I²C-bus switch with reset

6.5 Voltage translation

The pass gate transistors of the PCA9548A are constructed such that the V_{DD} voltage can be used to limit the maximum voltage that will be passed from one I²C-bus to another.

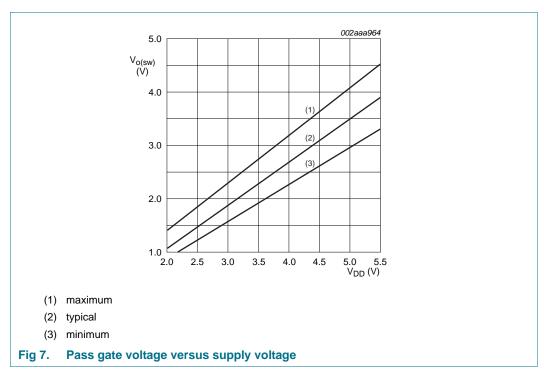


Figure 7 shows the voltage characteristics of the pass gate transistors (note that the PCA9548A is only tested at the points specified in Section 11 "Static characteristics" of this data sheet). In order for the PCA9548A to act as a voltage translator, the $V_{o(sw)}$ voltage should be equal to, or lower than the lowest bus voltage. For example, if the main bus was running at 5 V, and the downstream buses were 3.3 V and 2.7 V, then $V_{o(sw)}$ should be equal to or below 2.7 V to effectively clamp the downstream bus voltages. Looking at Figure 7, we see that $V_{o(sw)(max)}$ will be at 2.7 V when the PCA9548A supply voltage is 3.5 V or lower, so the PCA9548A supply voltage could be set to 3.3 V. Pull-up resistors can then be used to bring the bus voltages to their appropriate levels (see Figure 14).

More Information can be found in Application Note AN262: PCA954X family of PC/SMBus multiplexers and switches.

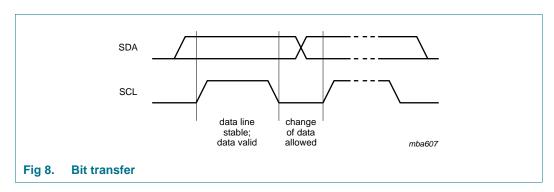
8-channel I2C-bus switch with reset

7. Characteristics of the I²C-bus

The I²C-bus is for 2-way, 2-line communication between different ICs or modules. The two lines are a serial data line (SDA) and a serial clock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor when connected to the output stages of a device. Data transfer may be initiated only when the bus is not busy.

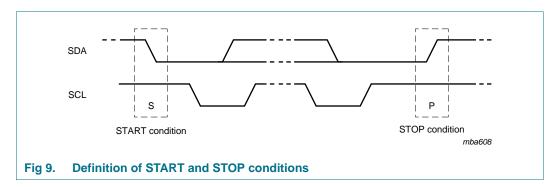
7.1 Bit transfer

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the HIGH period of the clock pulse as changes in the data line at this time will be interpreted as control signals (see Figure 8).



7.2 START and STOP conditions

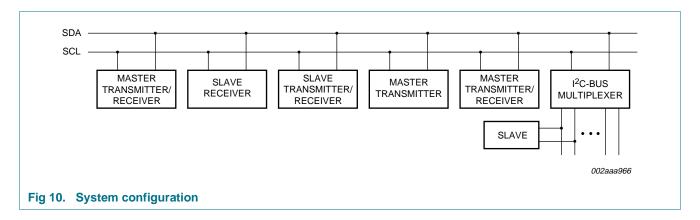
Both data and clock lines remain HIGH when the bus is not busy. A HIGH-to-LOW transition of the data line while the clock is HIGH is defined as the START condition (S). A LOW-to-HIGH transition of the data line while the clock is HIGH is defined as the STOP condition (P) (see Figure 9).



7.3 System configuration

A device generating a message is a 'transmitter', a device receiving is the 'receiver'. The device that controls the message is the 'master' and the devices which are controlled by the master are the 'slaves' (see Figure 10).

8-channel I²C-bus switch with reset

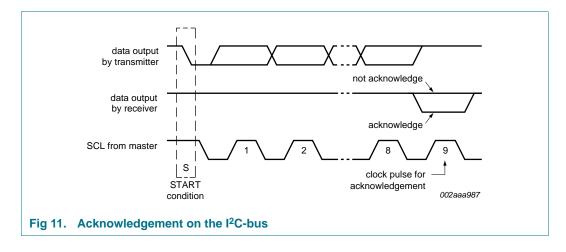


7.4 Acknowledge

The number of data bytes transferred between the START and the STOP conditions from transmitter to receiver is not limited. Each byte of eight bits is followed by one acknowledge bit. The acknowledge bit is a HIGH level put on the bus by the transmitter, whereas the master generates an extra acknowledge related clock pulse.

A slave receiver which is addressed must generate an acknowledge after the reception of each byte. Also, a master must generate an acknowledge after the reception of each byte that has been clocked out of the slave transmitter. The device that acknowledges has to pull down the SDA line during the acknowledge clock pulse so that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse; set-up and hold times must be taken into account.

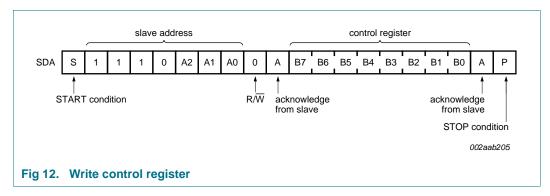
A master receiver must signal an end of data to the transmitter by not generating an acknowledge on the last byte that has been clocked out of the slave. In this event, the transmitter must leave the data line HIGH to enable the master to generate a STOP condition.



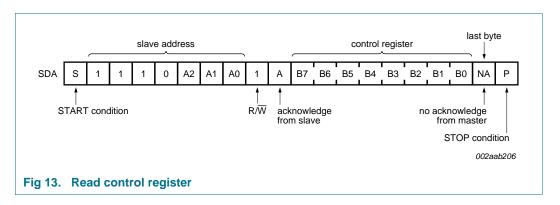
8-channel I²C-bus switch with reset

7.5 Bus transactions

Data is transmitted to the PCA9548A control register using the Write mode as shown in Figure 12.

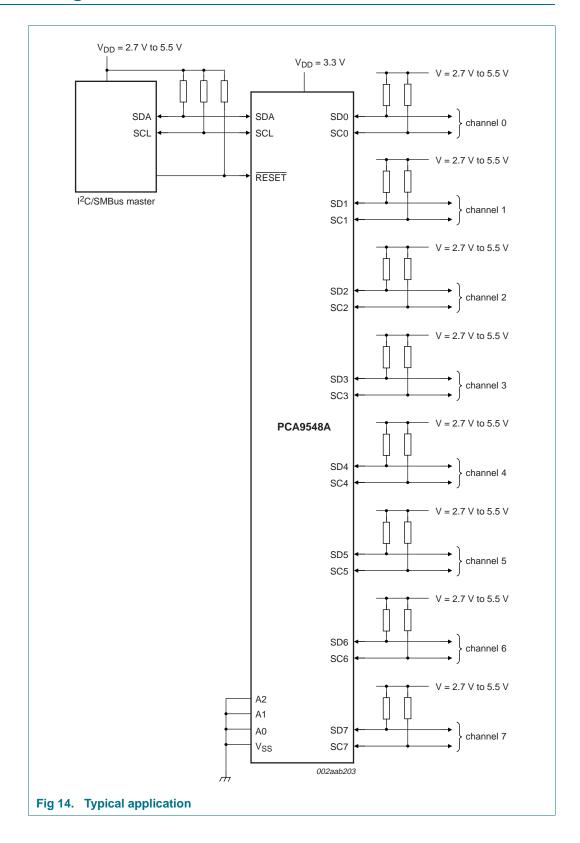


Data is read from PCA9548A using the Read mode as shown in Figure 13.



8-channel I²C-bus switch with reset

8. Application design-in information



8-channel I²C-bus switch with reset

9. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to $V_{\rm SS}$ (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DD}	supply voltage		-0.5	+7.0	V
VI	input voltage		-0.5	+7.0	V
I _I	input current		-	±20	mA
I _O	output current		-	±25	mA
I _{DD}	supply current		-	±100	mA
I_{SS}	ground supply current		-	±100	mA
P _{tot}	total power dissipation		-	400	mW
$T_{j(max)}$	maximum junction temperature		<u>[1]</u> -	125	°C
T_{stg}	storage temperature		-60	+150	°C
T _{amb}	ambient temperature	operating	-40	+85	°C

^[1] The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 125 °C.

10. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
$R_{th(j-a)}$	thermal resistance from junction	HVQFN24 package	40	°C/W
	to ambient	SO24 package	77	°C/W
		TSSOP24 package	128	°C/W

8-channel I²C-bus switch with reset

11. Static characteristics

Table 7. Static characteristics at $V_{DD} = 2.3 \text{ V}$ to 3.6 V

 $V_{SS} = 0 \text{ V}$; $T_{amb} = -40 \text{ }^{\circ}\text{C}$ to +85 $^{\circ}\text{C}$; unless otherwise specified. See <u>Table 8 on page 15</u> for $V_{DD} = 4.5 \text{ V}$ to 5.5 V_{color}

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Supply						
V_{DD}	supply voltage		2.3	-	3.6	V
I_{DD}	supply current	operating mode; V_{DD} = 3.6 V; no load; V_{I} = V_{DD} or V_{SS} ; f_{SCL} = 100 kHz	-	30	50	μΑ
I _{stb}	standby current	standby mode; $V_{DD} = 3.6 \text{ V}$; no load; $V_{I} = V_{DD}$ or V_{SS}	-	0.1	1	μА
V_{POR}	power-on reset voltage	no load; $V_I = V_{DD}$ or V_{SS}	[2] _	1.6	2.1	V
Input SCI	_; input/output SDA					
V _{IL}	LOW-level input voltage		-0.5	-	+0.3V _{DD}	V
V _{IH}	HIGH-level input voltage		$0.7V_{DD}$	-	6	V
I _{OL}	LOW-level output current	V _{OL} = 0.4 V	3	6	-	mA
		V _{OL} = 0.6 V	6	9	-	mA
IL	leakage current	$V_I = V_{DD}$ or V_{SS}	-1	-	+1	μΑ
Ci	input capacitance	$V_I = V_{SS}$	-	15	21	pF
Select in	outs A0 to A2, RESET					
V_{IL}	LOW-level input voltage		-0.5	-	+0.3V _{DD}	V
V_{IH}	HIGH-level input voltage		$0.7V_{DD}$	-	6	V
ILI	input leakage current	pin at V _{DD} or V _{SS}	-1	-	+1	μΑ
Ci	input capacitance	$V_I = V_{SS}$	-	2	5	pF
Pass gate						
R _{on}	ON-state resistance	$V_{DD} = 3.0 \text{ V to } 3.6 \text{ V}; V_{O} = 0.4 \text{ V};$ $I_{O} = 15 \text{ mA}$	5	11	30	Ω
		V_{DD} = 2.3 V to 2.7 V; V_{O} = 0.4 V; I_{O} = 10 mA	7	16	55	Ω
V _{o(sw)}	switch output voltage	$V_{i(sw)} = V_{DD} = 3.3 \text{ V}; I_{o(sw)} = -100 \mu\text{A}$	-	1.9	-	V
		$V_{i(sw)} = V_{DD} = 3.0 \text{ V to } 3.6 \text{ V};$ $I_{o(sw)} = -100 \mu\text{A}$	1.6	-	2.8	V
		$V_{i(sw)} = V_{DD} = 2.5 \text{ V}; I_{o(sw)} = -100 \mu\text{A}$	-	1.5	-	V
		$V_{i(sw)} = V_{DD} = 2.3 \text{ V to } 2.7 \text{ V};$ $I_{o(sw)} = -100 \mu\text{A}$	1.1	-	2.0	V
IL	leakage current	$V_{I} = V_{DD}$ or V_{SS}	-1	-	+1	μΑ
C _{io}	input/output capacitance	$V_I = V_{SS}$	-	3	5	pF

^[1] For operation between published voltage ranges, refer to the worst-case parameter in both ranges.

^[2] V_{DD} must be lowered to 0.2 V for at least 5 μs in order to reset part.

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8-channel I²C-bus switch with reset

Table 8. Static characteristics at $V_{DD} = 4.5 \text{ V}$ to 5.5 V $V_{SS} = 0 \text{ V}$; $T_{amb} = -40 \text{ °C}$ to +85 °C; unless otherwise specified. See <u>Table 7 on page 14</u> for $V_{DD} = 2.3 \text{ V}$ to 3.6 V.[1]

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Supply							
V_{DD}	supply voltage			4.5	-	5.5	V
I _{DD}	supply current	operating mode; $V_{DD} = 5.5 \text{ V}$; no load; $V_{I} = V_{DD}$ or V_{SS} ; $f_{SCL} = 100 \text{ kHz}$		-	65	100	μА
I _{stb}	standby current	standby mode; $V_{DD} = 5.5 \text{ V}$; no load; $V_{I} = V_{DD} \text{ or } V_{SS}$		-	0.2	1	μΑ
V_{POR}	power-on reset voltage	no load; $V_I = V_{DD}$ or V_{SS}	[2]	-	1.7	2.1	V
Input SCL	.; input/output SDA						
V_{IL}	LOW-level input voltage			-0.5	-	+0.3V _{DD}	V
V_{IH}	HIGH-level input voltage			$0.7V_{DD}$	-	6	V
I _{OL}	LOW-level output current	V _{OL} = 0.4 V		3	-	-	mΑ
		V _{OL} = 0.6 V		6	-	-	mΑ
I _{IL}	LOW-level input current	$V_I = V_{SS}$		-1	-	+1	μΑ
I _{IH}	HIGH-level input current	$V_I = V_{DD}$		-1	-	+1	μΑ
Ci	input capacitance	$V_I = V_{SS}$		-	15	21	pF
Select inp	outs A0 to A2, RESET						
V_{IL}	LOW-level input voltage			-0.5	-	+0.3V _{DD}	V
V_{IH}	HIGH-level input voltage			$0.7V_{DD}$	-	6	V
ILI	input leakage current	pin at V _{DD} or V _{SS}		-1	-	+1	μΑ
Ci	input capacitance	$V_I = V_{SS}$		-	2	5	pF
Pass gate)						
R _{on}	ON-state resistance	V_{DD} = 4.5 V to 5.5 V; V_{O} = 0.4 V; I_{O} = 15 mA		4	9	24	Ω
$V_{o(sw)}$	switch output voltage	$V_{i(sw)} = V_{DD} = 5.0 \text{ V};$ $I_{o(sw)} = -100 \mu\text{A}$		-	3.6	-	V
		$\begin{split} V_{i(sw)} &= V_{DD} = 4.5 \text{ V to } 5.5 \text{ V}; \\ I_{o(sw)} &= -100 \mu\text{A} \end{split}$		2.6	-	4.5	V
IL	leakage current	$V_I = V_{DD}$ or V_{SS}		-1	-	+1	μΑ
Cio	input/output capacitance	$V_I = V_{SS}$		-	3	5	pF

^[1] For operation between published voltage ranges, refer to the worst-case parameter in both ranges.

^[2] V_{DD} must be lowered to 0.2 V for at least 5 μs in order to reset part.

8-channel I²C-bus switch with reset

12. Dynamic characteristics

Table 9. Dynamic characteristics

Symbol	Parameter	Conditions			d-mode bus	Fast-mode I ²	Unit	
				Min	Max	Min	Max	
t _{PD}	propagation delay	from SDA to SDx, or SCL to SCx		-	0.3[1]	-	0.3[1]	ns
f _{SCL}	SCL clock frequency			0	100	0	400	kHz
t _{BUF}	bus free time between a STOP and START condition			4.7	-	1.3	-	μS
t _{HD;STA}	hold time (repeated) START condition		[2]	4.0	-	0.6	-	μS
t_{LOW}	LOW period of the SCL clock			4.7	-	1.3	-	μS
t _{HIGH}	HIGH period of the SCL clock			4.0	-	0.6	-	μS
t _{SU;STA}	set-up time for a repeated START condition			4.7	-	0.6	-	μS
t _{SU;STO}	set-up time for STOP condition			4.0	-	0.6	-	μS
$t_{\text{HD};\text{DAT}}$	data hold time			0[3]	<u>[4]</u>	0[3]	<u>[4]</u>	μS
$t_{\text{SU;DAT}}$	data set-up time			250	-	100	-	ns
t _r	rise time of both SDA and SCL signals			-	1000	$20 + 0.1C_b$	300	ns
t _f	fall time of both SDA and SCL signals			-	300	20 + 0.1C _b [5]	300	ns
C _b	capacitive load for each bus line			-	400	-	400	pF
t _{SP}	pulse width of spikes that must be suppressed by the input filter			-	50	-	50	ns
$t_{VD;DAT}$	data valid time	HIGH-to-LOW	[6]	-	1	-	1	μS
		LOW-to-HIGH	[6]	-	0.6	-	0.6	μS
t _{VD;ACK}	data valid acknowledge time			-	1	-	1	μS
RESET								
$t_{w(rst)L}$	LOW-level reset time			4	-	4	-	ns
t _{rst}	reset time	SDA clear		-	500	-	500	ns
$t_{REC;STA}$	recovery time to START condition			0	-	0	-	ns

^[1] Pass gate propagation delay is calculated from the 20 Ω typical R_{on} and the 15 pF load capacitance.

^[2] After this period, the first clock pulse is generated.

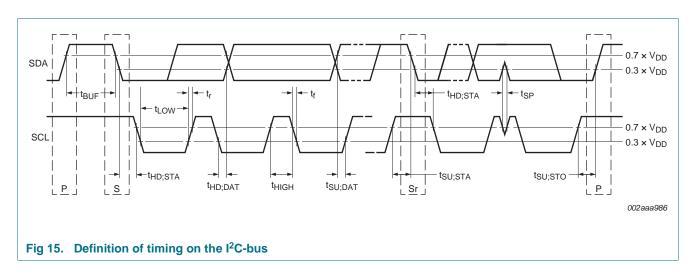
^[3] A device must internally provide a hold time of at least 300 ns for the SDA signal (referred to the V_{IH(min)} of the SCL signal) in order to bridge the undefined region of the falling edge of SCL.

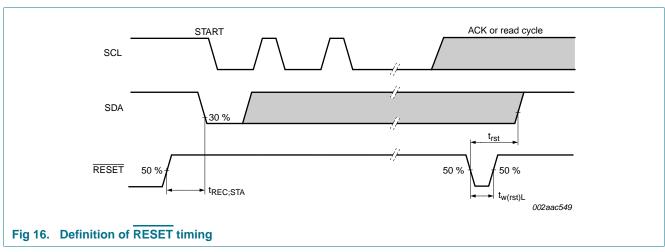
^[4] The maximum t_{HD;DAT} could be 3.45 μs and 0.9 μs for Standard-mode and Fast-mode, but must be less than the maximum of t_{VD;DAT} or t_{VD;ACK} by a transition time. This maximum must only be met if the device does not stretch the LOW period (t_{LOW}) of the SCL signal. If the clock stretches the SCL, the data must be valid by the set-up time before it releases the clock.

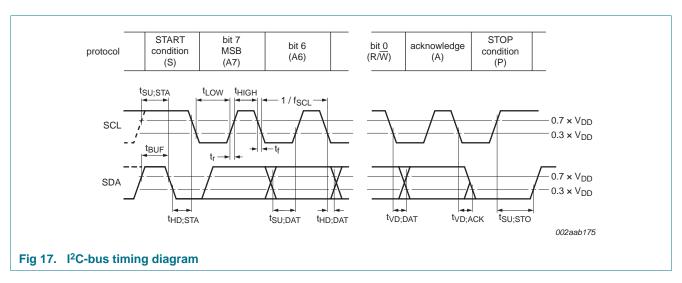
^[5] $C_b = \text{total capacitance of one bus line in pF.}$

^[6] Measurements taken with 1 k Ω pull-up resistor and 50 pF load.

8-channel I²C-bus switch with reset





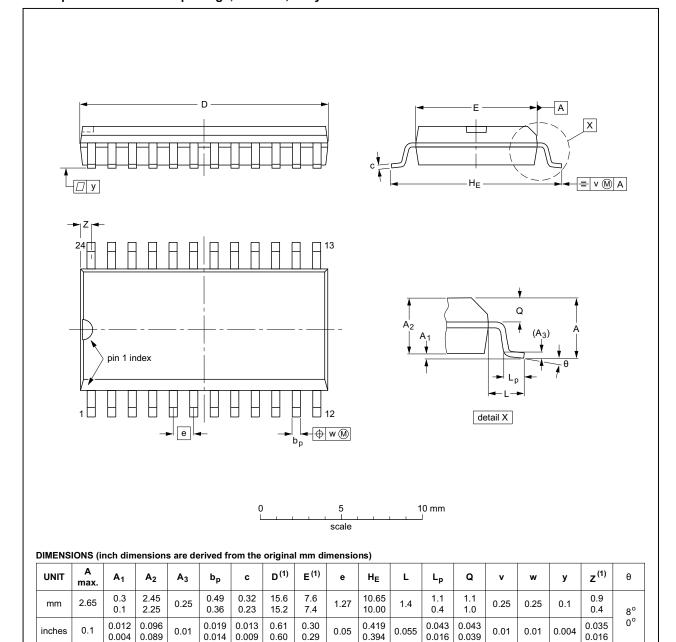


8-channel I²C-bus switch with reset

13. Package outline

SO24: plastic small outline package; 24 leads; body width 7.5 mm

SOT137-1



Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT137-1	075E05	MS-013			99-12-27 03-02-19

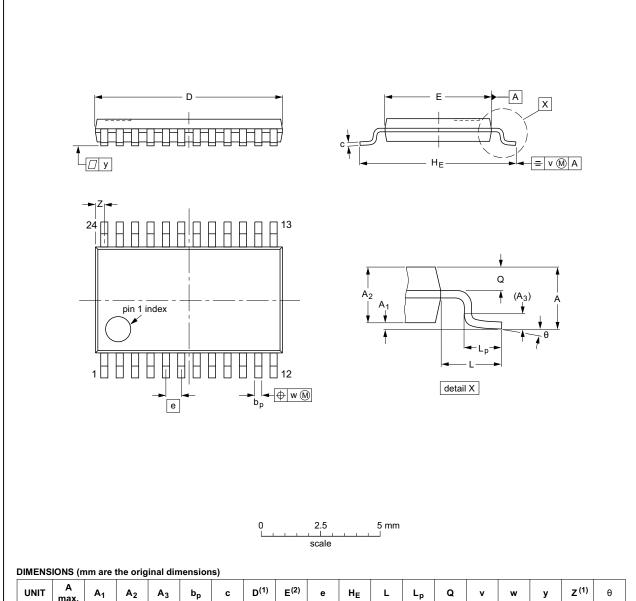
Fig 18. Package outline SOT137-1 (SO24)

CA9548A

8-channel I²C-bus switch with reset

TSSOP24: plastic thin shrink small outline package; 24 leads; body width 4.4 mm

SOT355-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	C	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	7.9 7.7	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

PROJECTION	ISSUE DATE
	99-12-27 03-02-19

Fig 19. Package outline SOT355-1 (TSSOP24)

PCA9548

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8-channel I²C-bus switch with reset

HVQFN24: plastic thermal enhanced very thin quad flat package; no leads; 24 terminals; body $4 \times 4 \times 0.85$ mm

SOT616-1

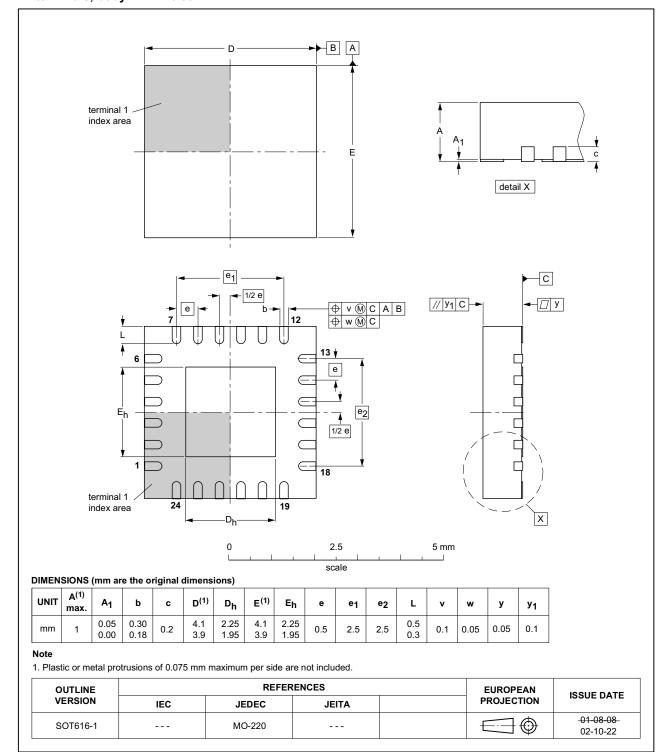


Fig 20. Package outline SOT616-1 (HVQFN24)

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14. Soldering of SMD packages

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note *AN10365* "Surface mount reflow soldering description".

14.1 Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

14.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- Through-hole components
- Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- · Board specifications, including the board finish, solder masks and vias
- · Package footprints, including solder thieves and orientation
- The moisture sensitivity level of the packages
- Package placement
- Inspection and repair
- · Lead-free soldering versus SnPb soldering

14.3 Wave soldering

Key characteristics in wave soldering are:

- Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- Solder bath specifications, including temperature and impurities

PCA9548A

8-channel I²C-bus switch with reset

14.4 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see <u>Figure 21</u>) than a SnPb process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board
- Reflow temperature profile; this profile includes preheat, reflow (in which the board is heated to the peak temperature) and cooling down. It is imperative that the peak temperature is high enough for the solder to make reliable solder joints (a solder paste characteristic). In addition, the peak temperature must be low enough that the packages and/or boards are not damaged. The peak temperature of the package depends on package thickness and volume and is classified in accordance with Table 10 and 11

Table 10. SnPb eutectic process (from J-STD-020D)

Package thickness (mm)	Package reflow temperature (°C)		
	Volume (mm³)		
	< 350	≥ 350	
< 2.5	235	220	
≥ 2.5	220	220	

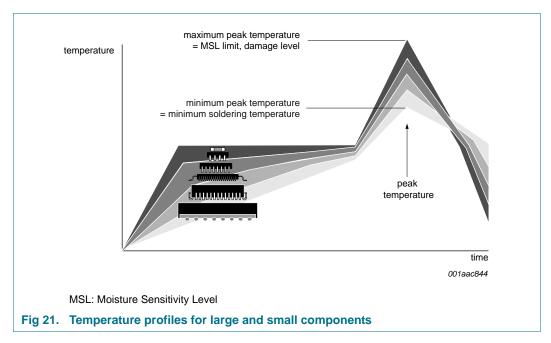
Table 11. Lead-free process (from J-STD-020D)

Package thickness (mm)	Package reflow temperature (°C) Volume (mm³)		
	< 350	350 to 2000	> 2000
< 1.6	260	260	260
1.6 to 2.5	260	250	245
> 2.5	250	245	245

Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see Figure 21.

8-channel I²C-bus switch with reset



For further information on temperature profiles, refer to Application Note *AN10365* "Surface mount reflow soldering description".

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15. Soldering: PCB footprints

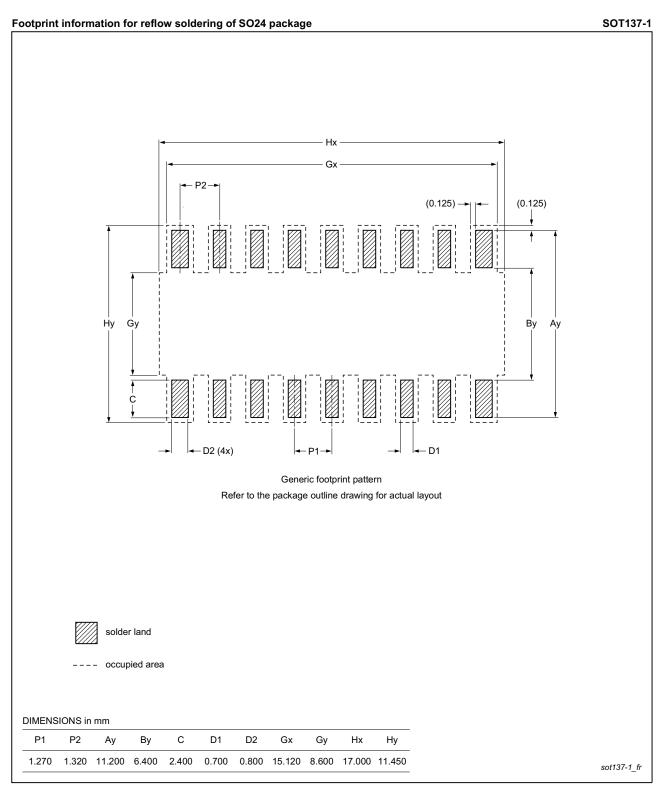


Fig 22. PCB footprint for SOT137-1 (SO24); reflow soldering

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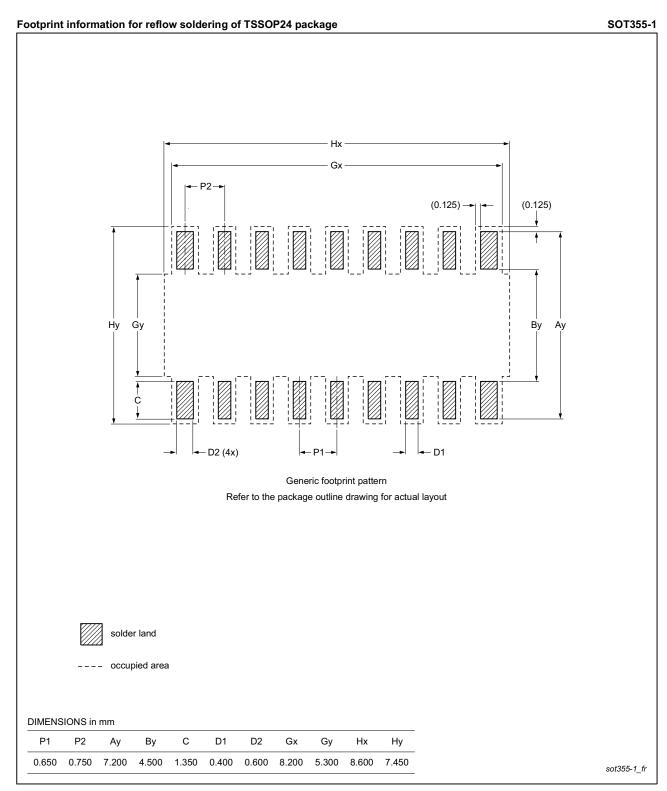


Fig 23. PCB footprint for SOT355-1 (TSSOP24); reflow soldering

8-channel I²C-bus switch with reset

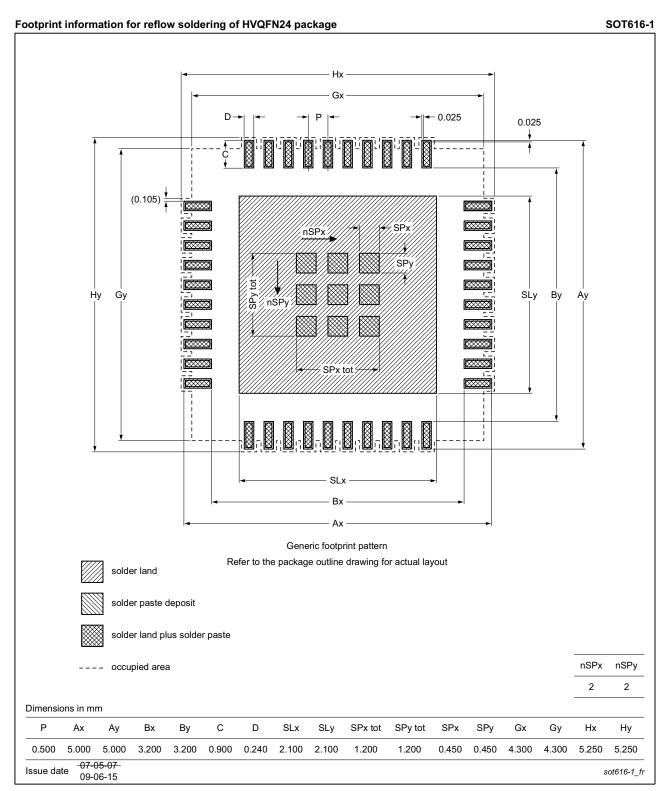


Fig 24. PCB footprint for SOT616-1 (HVQFN24); reflow soldering

8-channel I²C-bus switch with reset

16. Abbreviations

Table 12. Abbreviations

Acronym	Description
CDM	Charged Device Model
ESD	ElectroStatic Discharge
НВМ	Human Body Model
IC	Integrated Circuit
I ² C-bus	Inter-Integrated Circuit bus
I/O	Input/Output
LSB	Least Significant Bit
MSB	Most Significant Bit
PCB	Printed-Circuit Board
POR	Power-On Reset
SMBus	System Management Bus

17. Revision history

Table 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PCA9548A v.5.1	20151001	Product data sheet	-	PCA9548A v.5
Modifications:	• Section 6.2.1 "Control register definition", first paragraph, third sentence: corrected from "The 2 LSBs of the control byte" to "The contents of the control byte".			
PCA9548A v.5	20140331	Product data sheet	-	PCA9548A v.4
PCA9548A v.4	20130215	Product data sheet	-	PCA9548A v.3
PCA9548A v.3	20090707	Product data sheet	-	PCA9548A v.2
PCA9548A v.2	20060925	Product data sheet	-	PCA9548A v.1
PCA9548A v.1	20050415	Product data sheet	-	-

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Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions"
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8-channel I²C-bus switch with reset

20. Contents

1	General description	. 1
2	Features and benefits	. 1
3	Ordering information	. 2
3.1	Ordering options	. 2
4	Block diagram	. 3
5	Pinning information	
5.1	Pinning	
5.2	Pin description	
6	Functional description	
6.1	Device address	. 6
6.2	Control register	. 6
6.2.1	Control register definition	
6.3	RESET input	
6.4	Power-on reset	
6.5	Voltage translation	
7	Characteristics of the I ² C-bus	
7.1	Bit transfer	
7.2 7.3	START and STOP conditions	
7.3 7.4	System configuration	. 9 10
7. 4 7.5	Bus transactions	11
8	Application design-in information	12
9	Limiting values	13
9 10	Thermal characteristics	13
10	Static characteristics	14
12	Dynamic characteristics	16
13	Package outline	18
14	Soldering of SMD packages	21
14.1	Introduction to soldering	21
14.2 14.3	Wave and reflow soldering	21 21
14.3	Wave soldering	22
15	Soldering: PCB footprints	24
. •	- · · · · · · · · · · · · · · · · · · ·	
16	Abbreviations	27
17	Revision history	27
18	Legal information	28
18.1	Data sheet status	28
18.2 18.3	Definitions	28 28
18.4	Disclaimers	28
10. 4	Contact information	
20	Contents	30

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